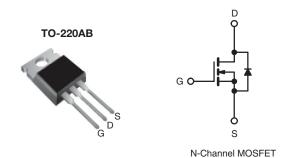


Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	100			
$R_{DS(on)}(\Omega)$	V _{GS} = 5.0 V 0.077			
Q _g (Max.) (nC)	64			
Q _{gs} (nC)	9.4			
Q _{gd} (nC)	27			
Configuration	Single			



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- R_{DS(on)} Specified at V_{GS} = 4 V and 5 V
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRL540PbF
Lead (FD)-liee	SiHL540-E3
SnPb	IRL540
	SiHL540

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V_{DS}	100		
Gate-Source Voltage	V_{GS}	± 10	V		
Continuous Drain Current	V_{GS} at 5.0 V $T_C = 25 ^{\circ}\text{C}$		28	А	
	V_{GS} at 5.0 V $T_C = 100 ^{\circ}C$	I _D	20		
Pulsed Drain Current ^a	I _{DM}	110			
Linear Derating Factor			1.0	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	440	mJ	
Avalanche Current ^a		I _{AR}	28	А	
Repetitive Avalanche Energy ^a		E _{AR}	15	mJ	
Maximum Power Dissipation	T _C = 25 °C	P_{D}	150	W	
Peak Diode Recovery dV/dtc	dV/dt	5.5	V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)		300 ^d			
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in	
Mounting Torque	0-32 OF IVIS SCIEW		1.1	N⋅m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 841 μ H, R_g = 25 Ω , I_{AS} = 28 A (see fig. 12c).
- c. $I_{SD} \le 28$ A, $dI/dt \le 170$ A/µs, $V_{DD} \le V_{DS}$, $T_{J} \le 175$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	
Case-to-Sink, Flat, Greasd Surface	R _{thCS}	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	100	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.12	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	1.0	-	2.0	V	
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 10 V	-	-	± 100	nA	
Zone Onto Valtana Busin Ormani		V _{DS} =	= 100 V, V _{GS} = 0 V	-	-	25		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V	V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA	
Drain-Source On-State Resistance	Б	V _{GS} = 5.0 V	I _D = 17 A ^b	-	-	0.077		
	R _{DS(on)}	V _{GS} = 4.0 V	I _D = 14 A ^b	-	-	0.11	Ω	
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 17 A	12	-	-	S	
Dynamic								
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,		2200	-		
Output Capacitance	C _{oss}]	$V_{DS} = 25 \text{ V},$	-	560	-	pF	
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	140	-	1	
Total Gate Charge	Qg			-	-	64		
Gate-Source Charge	Q _{gs}	V _{GS} = 5.0 V	$I_D = 28 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 ^b	-	-	9.4	nC	
Gate-Drain Charge	Q_{gd}		goo ng. o ana ro	-	-	27]	
Turn-On Delay Time	t _{d(on)}			-	8.5	-		
Rise Time	t _r	Von	= 50 V, I _D = 28 A,	-	170	-]	
Turn-Off Delay Time	t _{d(off)}	$R_g = 9.0 \Omega$, $R_D = 1.7 \Omega$, see fig. 10^b		-	35	-	ns	
Fall Time	t _f			-	80	-]	
Internal Drain Inductance	L _D	package and center of		4.5	-	n⊔		
Internal Source Inductance	L _S			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	28	- A	
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction	¬ — ¬	_	-	110		
Body Diode Voltage	V_{SD}	T _J = 25 °C	C, I _S = 28 A, V _{GS} = 0 V ^b	-	-	2.5	V	
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C !	- 28 A dl/dt = 100 A/ah	_	200	260	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$-$ T _J = 25 °C, I _F = 28 A, dl/dt = 100 A/ μ s ^b		-	1.7	2.90	μC	
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	y L _S and	L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

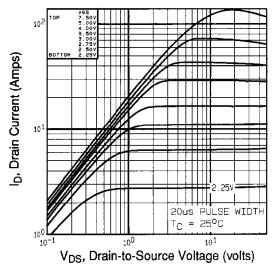


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

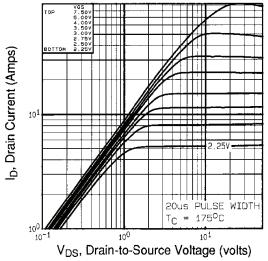


Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C

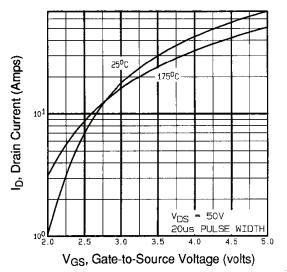


Fig. 3 - Typical Transfer Characteristics

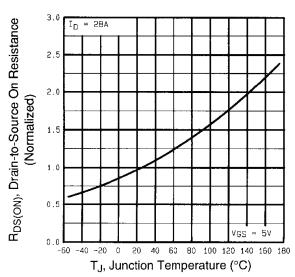


Fig. 4 - Normalized On-Resistance vs. Temperature



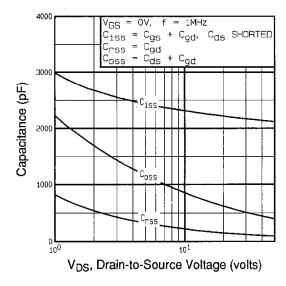


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

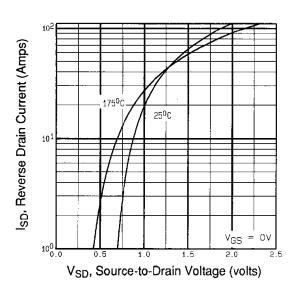


Fig. 7 - Typical Source-Drain Diode Forward Voltage

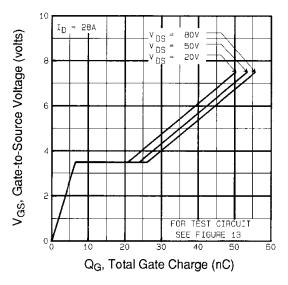


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

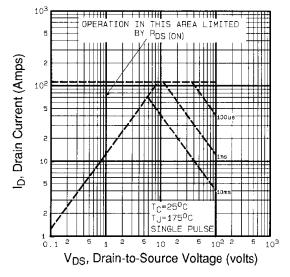


Fig. 8 - Maximum Safe Operating Area





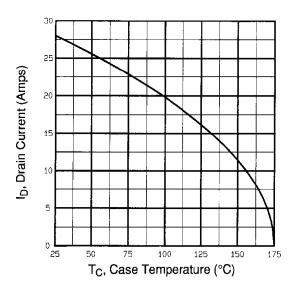


Fig. 9 - Maximum Safe Operating Area

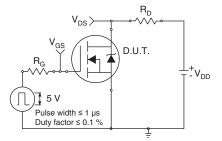


Fig. 10a - Switching Time Test Circuit

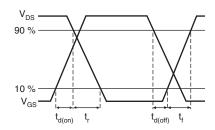


Fig. 10b - Switching Time Waveforms

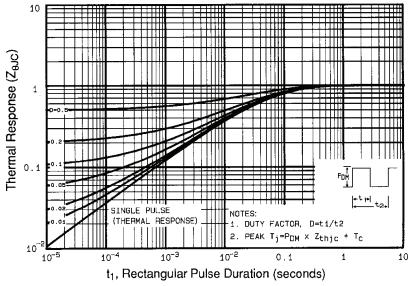
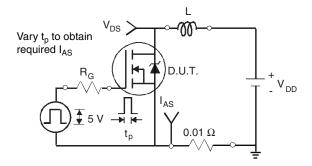


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





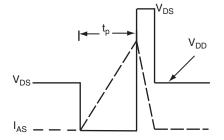


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

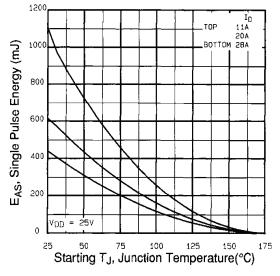


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

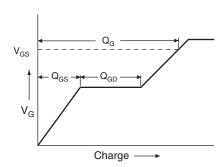


Fig. 13a - Basic Gate Charge Waveform

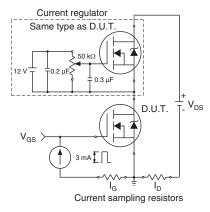
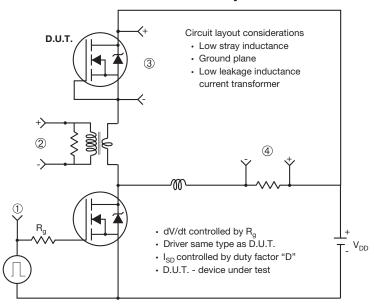


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



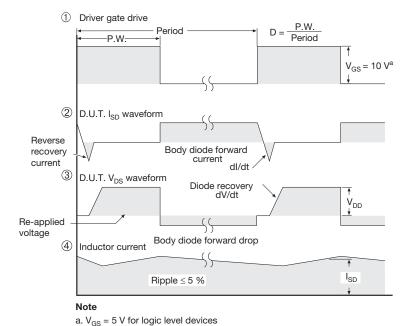


Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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